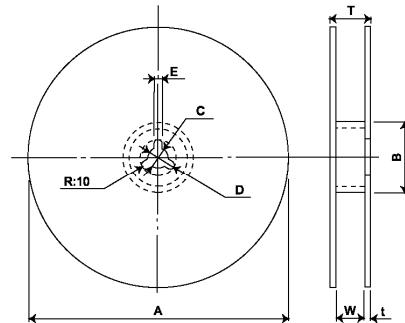




Surface Mount Aluminum Electrolytic Capacitors

Packaging Specifications

•Reel Dimensions in mm(not to scale)

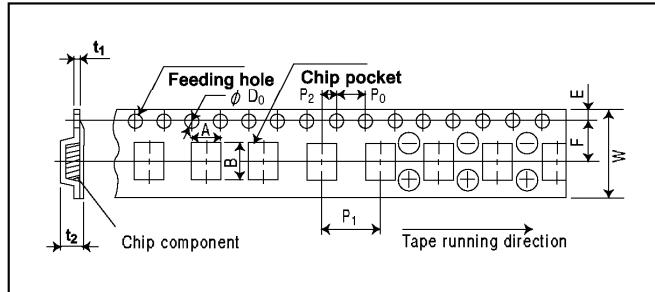


Size	A	B	C	D	E	W	T	t
$\phi 3 \sim \phi 5$	380 ± 2	50min	13.0 ± 0.5	21.0 ± 0.8	2.0 ± 0.5	14 ± 1	20 ± 1	3.0
$\phi 6.3 \sim \phi 8^*1$	380 ± 2	50min	13.0 ± 0.5	21.0 ± 0.8	2.0 ± 0.5	18 ± 1	24 ± 1	3.0
$\phi 8^*2 \sim \phi 10$	380 ± 2	50min	13.0 ± 0.5	21.0 ± 0.8	2.0 ± 0.5	26 ± 1	32 ± 1	3.0

*1: = 6.2 mm *2: = 10.2 mm

Taping Dimensions in mm(not to scale)

Code A : Reel Taping



* Ask factory for technical specifications.

Size	W	A	B	$P_0 \pm 0.1$	P_1	$P_2 \pm 0.1$	F	ϕD_0	t1	E	t2
$\phi 3 \times 5.4$	12.0	3.4	3.5	4.0	8.0	2.0	5.5	$1.5^{+0.1}_{-0}$	0.4	1.75	5.8
$\phi 4 \times 5.4$	12.0	4.7	4.6	4.0	8.0	2.0	5.5	$1.5^{+0.1}_{-0}$	0.4	1.75	5.8
$\phi 5 \times 5.4$	12.0	6.0	6.0	4.0	12.0	2.0	5.5	$1.5^{+0.1}_{-0}$	0.4	1.75	5.8
$\phi 6.3 \times 5.4$	16.0	7.1	7.0	4.0	12.0	2.0	7.5	$1.5^{+0.1}_{-0}$	0.4	1.75	5.8
$\phi 8 \times 6.2$	16.0	8.7	8.7	4.0	12.0	2.0	7.5	$1.5^{+0.1}_{-0}$	0.4	1.75	6.8
$\phi 8 \times 10.2$	24.0	8.7	8.7	4.0	16.0	2.0	11.5	$1.5^{+0.1}_{-0}$	0.4	1.75	11.0
$\phi 10 \times 10.2$	24.0	10.7	10.7	4.0	16.0	2.0	11.5	$1.5^{+0.1}_{-0}$	0.4	1.75	11.0

Packaging Quantity

Size	Inner packaging	Outer packaging
$\phi 3 \times 5.4$	2000	20000
$\phi 4 \times 5.4$	2000	20000
$\phi 5 \times 5.4$	1000	10000
$\phi 6.3 \times 5.4$	1000	10000
$\phi 8 \times 6.2$	1000	10000
$\phi 8 \times 10.2$	500	3000
$\phi 10 \times 10.2$	500	3000

Chip Film Capacitors



CFC

Surface Mount Stacked Metallized Polyester Film Capacitors

- Stacked metallized polyester film construction
- Very small sizes in EIA 1206, 1210, 1913, 2416 sizes
- Excellent moisture resistance
- Reflow soldering applicable
- Tape/reel package
- Wide temperature range and high stability
- Stable temperature, frequency and bias characteristics
- Please consult factory for other dielectrics

Specifications:

Item	Characteristics/Specifications	
Operating Temperature Range at Rated Voltage	-55~+105°C	
Rated Voltage	16, 50, 100 VDC	
Rated Capacitance Range (20°C 1KHz)	1000PF ~ .47μF	
Capacitance Tolerance	±5 (J)	
Maximum Dissipation Factor (20°C 1KHz)	1.0%	
Minimum Insulation Resistance (20°C) after 1 minute	3,000M at rated dc voltage except 16Vdc. 16Vdc rating should be measured at 10Vdc	
Withstanding Voltage (between terminals) applied through min. 2K resistor	1.5 times of rated voltage for 1 minute or 1.75 times for 1-5 seconds	
Life Test at 105°C 1,000 hours with 125% of rated voltage	Capacitance Change	Within -6~ +1% of initial measured value
	Dissipation Factor	Maximum 1.1%
	Insulation Resistance	More than 1,000M between terminals
Humidity Load Test 1 at 40°C & 90-95% RH 1,000 hours with Rated voltage	Capacitance Change	Within -5~ +8% of initial measured value
	Dissipation Factor	Maximum 1.5%
	Insulation Resistance	Minimum 100M between terminals
	Withstanding Voltage	Withstand 130% of rated voltage for 1 min.
Humidity Load Test 2 at 60°C & 90-95% RH 500 hours with Rated voltage	Capacitance Change	Within ±10% of initial measured value
	Dissipation Factor	Maximum 2.0%
	Insulation Resistance	Minimum 10M
	Withstanding Voltage	Withstand 130% of rated voltage for 1 min.
Temperature Stability	C/C at -55°C	Within ±3% of initial value at 20°C
	C/C at +105°C	Within ±4% of initial value at 20°C
Resistance to Soldering Heat Reflow with peak at 240 ±3°C and preheating at 155°C for 90 sec.	Capacitance Change	Within ±5% of initial measured value
	Dissipation Factor	Maximum 1.1%
	Insulation Resistance	Minimum 1000M
	Withstanding Voltage	1.5 times of rated voltage for 1 minute or 1.75 times for 1-5 seconds
Solderability		
Terminal shall be immersed into 10%wt rosin-methanol flux, and then immersed into molten solder at 235±5°C. The solder coverage shall be more than 90% of electrode.		

Dimensions in mm:

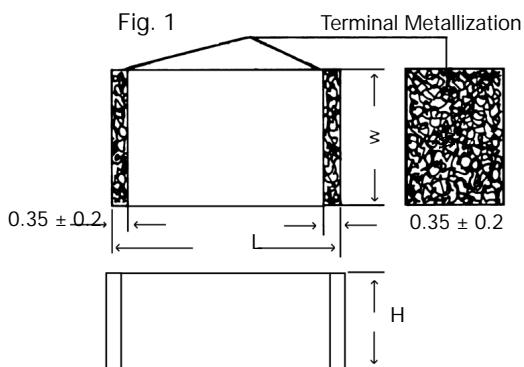


Chart 1: Case Size Code = EIA Size + Height Code

EIA Size	Case Code	Dimensions (mm)			
		L ± 0.2	W	H ± 0.2	A
1206	B1	3.2	1.6 ±0.2	0.8	0.35 ±0.2
	B2			1.0	
	B3			1.4	
1210	C1	3.2	2.5 ±0.2	1.0	0.35 ±0.2
	C2			1.4	
	C3			2.4	
1913	D1	4.8	3.3 ±0.3	1.4	0.35 ±0.2
	D2			2.0	
	D3			2.8	
2416	E1	6.0	4.12 ±0.3	1.8	0.43 ±0.3
	E2			2.0	
	E3			2.4	
	E4			2.8	



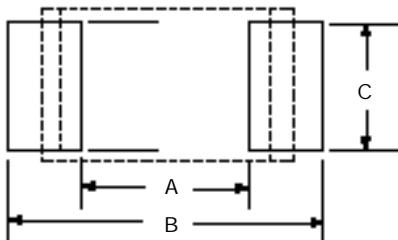
Chip Film Capacitors

CFC - Standard Products Table

Voltage	16 VDC				50 VDC				100 VDC		
EIA Size	1206	1210	1913	2416	1206	1210	1913	2416	1206	1210	1913
0.0010µF									B2		
0.0012µF									B2		
0.0015µF									B2		
0.0018µF									B2		
0.0022µF									B2		
0.0027µF									B2		
0.0033µF					B1				B3		
0.0039µF					B1				B3		
0.0047µF					B1				B3		
0.0056µF					B1					C2	
0.0068µF					B1					C2	
0.0082µF					B2					C3	
0.010µF					B2					C3	
0.012µF	B2					C1					D1
0.015µF	B2					C1					D1
0.018µF	B2					C2					D1
0.022µF	B2					C2					D1
0.027µF	B2					C2					D1
0.033µF	B3					C3					D1
0.039µF	B3					C3					D1
0.047µF	B3					C3					D2
0.056µF		C2					D2				
0.068µF		C2					D2				
0.082µF		C3					D3				
0.1µF		C3					D4				
0.12µF			D1					E1			
0.15µF			D2					E2			
0.18µF			D2					E3			
0.22µF			D3					E4			
0.27µF				E1							
0.33µF				E2							
0.39µF				E3							
0.47µF				E4							

Handling Cautions and Recommendations:

1. Recommended Land Pattern (mm)



Example for Land Dimensions (mm)

Code	Land Dimensions					
	Flow Soldering			Reflow Soldering		
	A	B	C	A	B	C
B1	2.2	3.8	1.4	2.2	3.8	1.4
B2	2.2	3.8	1.4	2.2	3.8	1.4
B3	2.2	3.8	1.4	2.2	3.8	1.4
C1	2.2	3.8	2.3	2.2	3.8	2.3
C2	2.2	3.8	2.3	2.2	3.8	2.3
C3	2.2	3.8	2.3	2.2	3.8	2.3

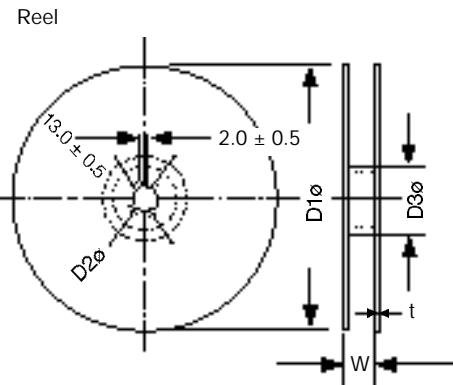
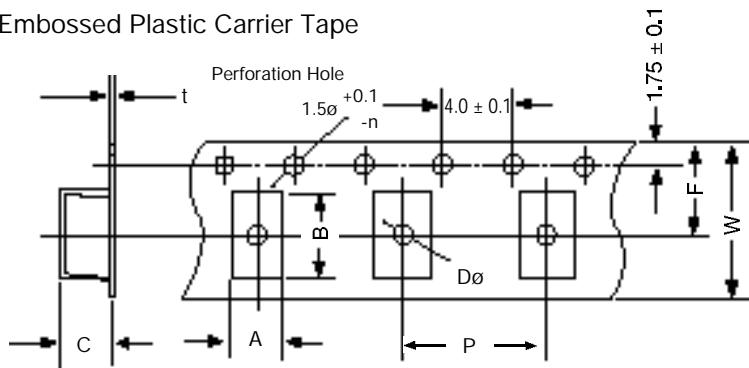
Code	Land Dimensions					
	Flow Soldering			Reflow Soldering		
	A	B	C	A	B	C
D1	2.6	6.6	3.0	2.6	6.6	3.0
D2	2.6	6.6	3.0	2.6	6.6	3.0
E1	3.8	7.8	3.8	3.8	7.8	3.8
E2	3.8	7.8	3.8	3.8	7.8	3.8
E3	3.8	7.8	3.8	3.8	7.8	3.8
E4	3.8	7.8	3.8	3.8	7.8	3.8

Chip Film Capacitors



CFC Taping Specifications:

Embossed Plastic Carrier Tape



Tape Dimensions (mm)

Case Size	A ± 0.1	B ± 0.1	C ± 0.2	t ± 0.3	W ± 0.3	F ± 0.05	P ± 0.1	D + 0.2 - 0
B 1	1.9	3.5	1.5	0.25	8.0	3.5	4.0	1.0
B 2			1.9					
B 3			1.9					
C 1	2.8	3.5	1.9	0.25	8.0	3.5	4.0	1.0
C 2			2.5					
C 3			2.5					
D 1	3.8	5.1	2.0	0.30	12.0	5.5	8.0	1.5
D 2			2.6					
D 3			3.4					
E 1	4.6	6.3	2.7	0.30	12.0	5.5	8.0	1.5
E 2			2.7					
E 3			3.5					

Reel Dimensions (mm) & Quantity per Reel (pcs)

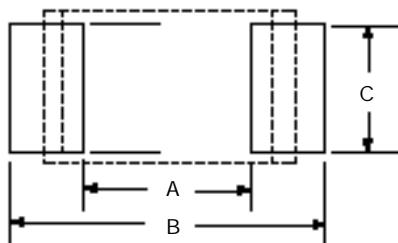
Case Code	D1 ± 2.0	D2	D3 ± 2.0	W	t ± 0.5	Q'ty/Reel
B 1	178	23.5 ± 0.5	60.0	9.5 ± 0.5	1.2	3,000
B 2						3,000
B 3						2,000
C 1	178	23.5 ± 0.5	60.0	9.5 ± 0.5	1.2	2,000
C 2						3,000
C 3						3,000
D 1	330	21.0 ± 0.8	80.0	14.0 ± 1.5	2.0	3,000
D 2						3,000
D 3						2,000
E 1	330	21.0 ± 0.8	80.0	14.0 ± 1.5	2.0	3,000
E 2						3,000
E 3						2,000

Note: Each reel has minimum 400mm leader tape and/or empty tape.

The ending of tape has minimum 400mm empty tape.

Handling Cautions and Recommendations:

1. Recommended Land Pattern (mm)



Case Code	EIA Size	A	B	C
B1 ~ B3	1206	2.2	3.8	1.4
C1 ~ C3	1210	2.2	3.8	2.3
D1 ~ D3	1913	2.6	6.6	3.0
E1 ~ E3	2416	3.8	7.8	3.8



Chip Film Capacitors

CFCH

Surface Mount Stacked Metallized Polyester Film Capacitors

- Stacked metallized polyester film construction
- Very small sizes in EIA 0805, 1206, 1210, 1913 sizes
- Excellent moisture resistance
- Reflow soldering applicable
- Tape/reel package
- Wide temperature range and high stability
- Stable temperature, frequency and bias characteristics
- Please consult factory for other dielectrics

Specifications:

Item	Characteristics/Specifications	
Operating Temperature Range at Rated Voltage	-55~+125°C	
Rated Voltage	16, 50 VDC	
Rated Capacitance Range (20°C 1KHz)	100PF ~ .1μF	
Capacitance Tolerance	±5 (J)	
Maximum Dissipation Factor (20°C 1Khz)	1.0%	
Minimum Insulation Resistance (20°C) after 1 minute	3,000M at rated dc voltage except 16Vdc. 16Vdc rating should be measured at 10Vdc	
Withstanding Voltage (between terminals) applied through min. 2K resistor	1.5 times of rated voltage for 1 minute or 1.75 times for 1-5 seconds	
Life Test at 105°C 1,000 hours with 125% of rated voltage	Capacitance Change	Within -6~ +1% of initial measured value
	Dissipation Factor	Maximum 1.1%
	Insulation Resistance	More than 1.000M between terminals
Humidity Load Test 1 at 40°C & 90-95% RH 1,000 hours with Rated voltage	Capacitance Change	Within -5~ +8% of initial measured value
	Dissipation Factor	Maximum 1.5%
	Insulation Resistance	Minimum 100M between terminals
	Withstanding Voltage	Withstand 130% of rated voltage for 1 min.
Humidity Load Test 2 at 60°C & 90-95% RH 500 hours with Rated voltage	Capacitance Change	Within ±10% of initial measured value
	Dissipation Factor	Maximum 2.0%
	Insulation Resistance	Minimum 10M
	Withstanding Voltage	Withstand 130% of rated voltage for 1 min.
Temperature Stability	C/C at -55°C	Within ±3% of initial value at 20°C
	C/C at +105°C	Within ±4% of initial value at 20°C
Resistance to Soldering Heat Reflow with peak at 240 ±3°C and preheating at 155°C for 90 sec.	Capacitance Change	Within ±5% of initial measured value
	Dissipation Factor	Maximum 1.1%
	Insulation Resistance	Minimum 1000M
	Withstanding Voltage	1.5 times of rated voltage for 1 minute or 1.75 times for 1-5 seconds
Solderability		
Terminal shall be immersed into 10%wt rosin-methanol flux, and then immersed into molten solder at 235±5°C. The solder coverage shall be more than 90% of electrode.		

Dimensions in mm:

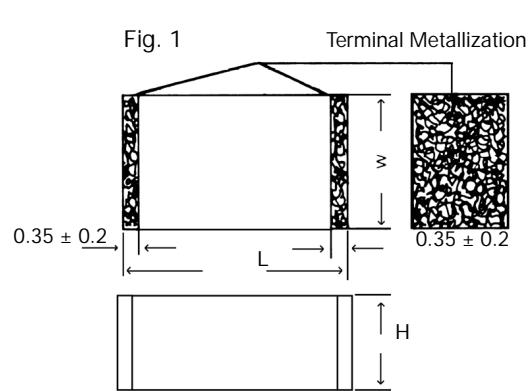


Chart 1: Case Size Code = EIA Size + Height Code

EIA Size	Case Code	Dimensions (mm)			
		L ± 0.2	W	H ± 0.2	A
0805	A1	2.0	1.2	0.8	0.35 ±0.2
	A2			1.0	
1206	B1	3.2	1.6 ±0.2	0.8	0.35 ±0.2
	B2			1.0	
	B3			1.4	
1210	C1	3.2	2.5 ±0.2	1.0	0.35 ±0.2
	C2			1.4	
	C3			2.4	
1913	D1	4.8	3.3 ±0.3	1.4	0.35 ±0.2
	D2			2.0	
	D3			2.8	

Chip Film Capacitors

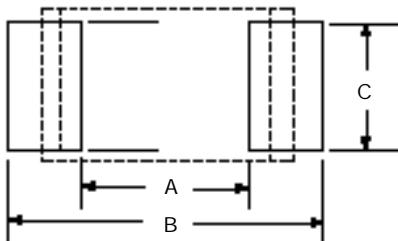


CFCH - Standard Products Table

Voltage	16 VDC			50 VDC			
EIA Size	0805	1206	1210	0805	1206	1210	1913
100pF				A1			
120pF				A1			
150pF				A1			
180pF				A1			
220pF				A1			
270pF				A1			
330pF				A1			
470pF				A1			
560pF				A1			
680pF				A1			
820pF				A1			
.001μF				A1			
.0012μF				A1			
.0015μF				A1			
.0018μF				A1			
.0022μF				A1			
.0027μF				A1			
.0033μF	A1				B1		
.0039μF	A1				B1		
.0047μF	A1				B1		
.0056μF	A1				B1		
.0068μF	A1				B1		
.0082μF	A2				B2		
.01μF	A2				B2		
.012μF		B1				C1	
.015μF		B1				C1	
.018μF		B1				C2	
.022μF		B1				C2	
.027μF		B2				C2	
.033μF		B2				C3	
.039μF		B3				C3	
.047μF		B3				D1	
.056μF			C2			D1	
.068μF			C2			D1	
.082μF			C3			D2	
.1μF			C3			D2	

Handling Cautions and Recommendations:

1. Recommended Land Pattern (mm)



Example for Land Dimensions (mm)

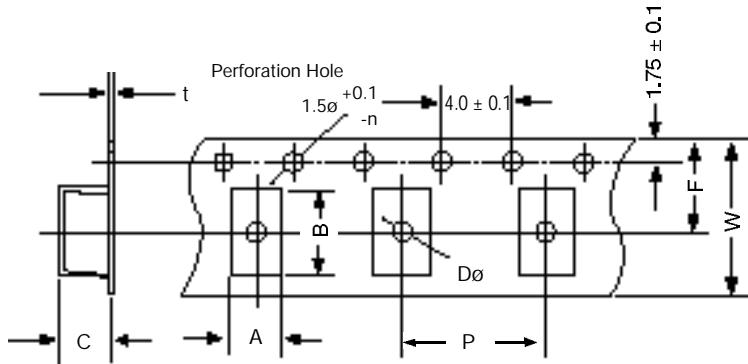
Code	Land Dimensions					
	Flow Soldering			Reflow Soldering		
	A	B	C	A	B	C
A1	1.0	2.7	1.1	1.0	2.7	1.1
A2	1.0	2.7	1.1	1.0	2.7	1.1
B1	2.2	3.8	1.4	2.2	3.8	1.4
B2	2.2	3.8	1.4	2.2	3.8	1.4
B3	2.2	3.8	1.4	2.2	3.8	1.4
C1	2.2	3.8	2.3	2.2	3.8	2.3
C2	2.2	3.8	2.3	2.2	3.8	2.3
C3	2.2	3.8	2.3	2.2	3.8	2.3
D1	2.6	6.6	3.0	2.6	6.6	3.0
D2	2.6	6.6	3.0	2.6	6.6	3.0



Chip Film Capacitors

CFCH

Chip Type Embossed Taping - Embossed Taping

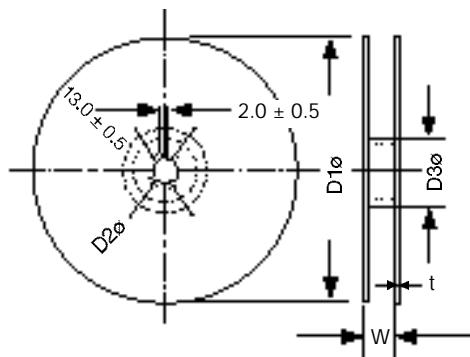


Standard Packaging Quantities

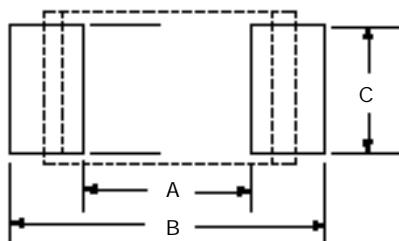
Size Code	Reel	Quantities
A1, A2, B1, B2	ø178	3000pcs/reel
B3, C1, C2, C3	ø178	2000pcs/reel
D1, D2	ø330	3000pcs/reel

Size Code	Dimensions (mm)												
	$A_0 \pm 0.1$	$B_0 \pm 0.1$	$W \pm 0.3$	$F \pm 0.05$	$E \pm 0.1$	$P \pm 0.1$	$P_0 \pm 0.05$	$P_0 \pm 0.1$	$\varnothing D_{1-0}^{+0.2}$	$\varnothing D_{1-0}^{+0.2}$	$T \pm 0.05$	$T_s \pm 0.2$	$K \pm 0.1$
A1	1.55	2.3	8.0	3.50	1.75	4.0	2.00	4.0	$\varnothing 1.5$	$\varnothing 1.0$	0.25	1.3	1.2
A2	1.55	2.3										1.5	1.4
B1, B2	1.9	3.5										1.5	1.4
B3	1.9	3.5										1.9	1.8
C1, C2	2.8	3.5										1.9	1.8
C3	2.8	3.5										2.5	2.4
D1	3.8	5.1	12.0	5.50	1.75	8.0	2.00	4.0	$\varnothing 1.5$	$\varnothing 1.5$	0.30	2.0	1.9
D2	3.8	5.1										2.6	2.5

Reel Dimensions



Leader Part and Tape End (mm)

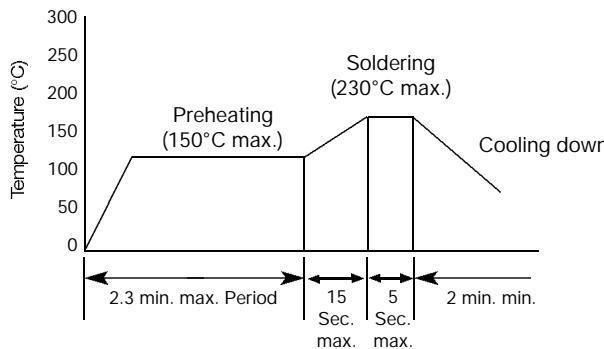


Chip Film Capacitors



CFC/CFCH

1. Flux without halogen content is recommended. Please consult factory for use of the flux with more than 0.1% halogen content which may damage the capacitor.
2. Recommended Soldering Conditions. (Only reflow is applicable and solder dripping not applicable).



3. Cleaning Conditions

- (1) Isopropyl alcohol is recommended under following conditions:
 - Dipping at room temperature: max. 5 minutes
 - Vapor less than 50°C: max. 5 minutes
 - Ultrasonic less than 50°C: max. 5 minutes

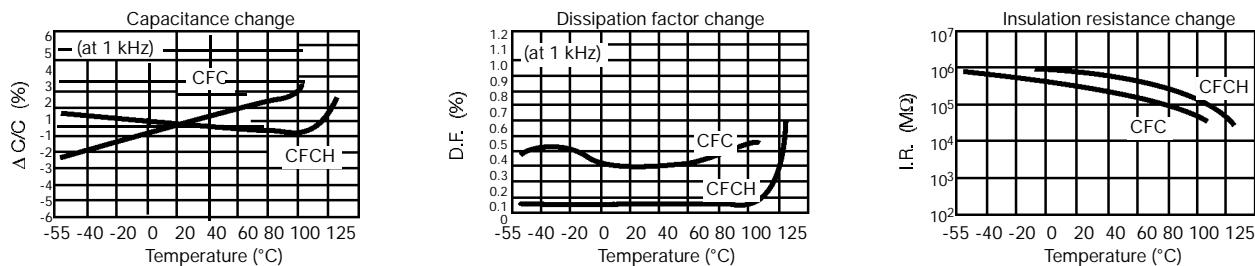
The freon family and trichloroethane can be applicable. In case of other cleaning agents or solvents, please consult our factory.

4. Storage under cool and low humidity without any harmful gas is recommended.

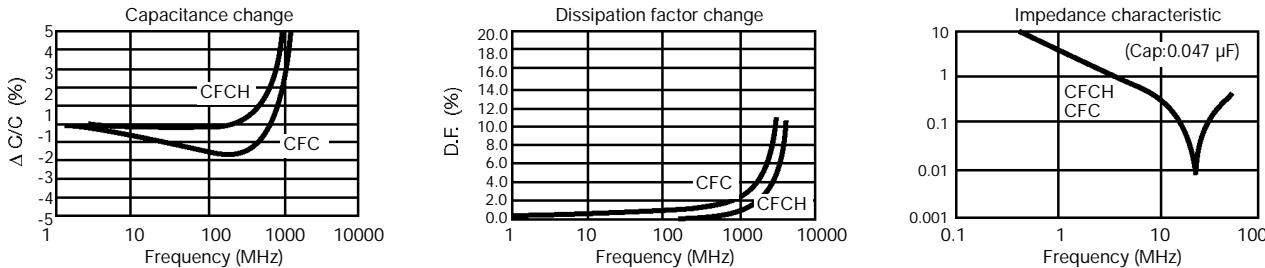
5. High frequency application.

The sum of DC voltage and peak value at AC voltage shall not exceed the rated voltage. Also, the capacitor shall be used in a condition that the self temperature rise shall not exceed 10°C at ambient temperature 40°C, and the sum of ambient temperature and self temperature rise shall not exceed 105°C.

Temperature Characteristics (Typical curve)



Frequency Characteristics (Typical curve)





Chip Film Capacitors

Part Numbering System

